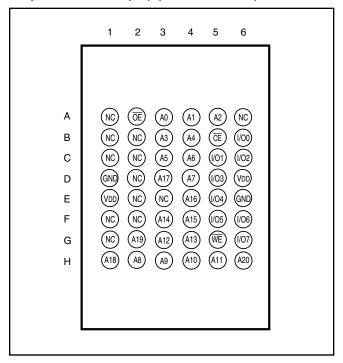
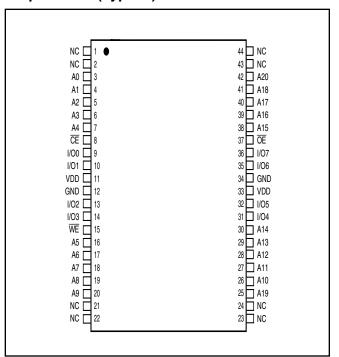


PIN CONFIGURATION

48-pin Mini BGA (M) (9mm x 11mm)



44-pin TSOP (Type II)



PIN DESCRIPTIONS

A0-A20	Address Inputs
CE	Chip Enable Input
ŌĒ	Output Enable Input
WE	Write Enable Input
I/O0-I/O	7 Data Input / Output
VDD	Power
GND	Ground
NC	No Connection



TRUTH TABLE

Mode	WE	CE	ŌĒ	I/O Operation	VDD Current
Not Selected (Power-down)	Х	Н	Х	High-Z	ISB1, ISB2
Output Disable	ed H	L	Н	High-Z	Icc
Read	Н	L	L	D оит	Icc
Write	L	L	Χ	Din	Icc

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameter	Value	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to $V_{DD} + 0.5$	٧
VDD	VDD Relates to GND	-0.3 to 4.0	٧
Тѕтс	Storage Temperature	-65 to +150	°C
Рт	Power Dissipation	1.0	W

Notes:

CAPACITANCE^(1,2)

Symbol	Parameter	Conditions	Max.	Unit	
Cin	Input Capacitance	VIN = 0V	6	pF	
C _{I/O}	Input/Output Capacitance	VOUT = $0V$	8	pF	

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

^{1.} Tested initially and after any design or process changes that may affect these parameters.

^{2.} Test conditions: $T_A = 25$ °C, f = 1 MHz, $V_{DD} = 3.3$ V.



OPERATING RANGE (VDD) (IS61WV20488ALL)

Range	Ambient Temperature	V _{DD} (20 ns)
Commercial	0°C to +70°C	1.65V-2.2V
Industrial	–40°C to +85°C	1.65V-2.2V
Automotive	-40°C to +125°C	1.65V-2.2V

OPERATING RANGE (VDD) (IS61WV20488BLL)(1)

Range	Ambient Temperature	V _{DD} (8 ns)	V _{DD} (10 ns)	
Commercial	0°C to +70°C	3.3V <u>+</u> 5%	2.4V-3.6V	
Industrial	-40°C to +85°C	3.3V <u>+</u> 5%	2.4V-3.6V	

Note:

OPERATING RANGE (VDD) (IS64WV20488BLL)

Range	Ambient Temperature	V _{DD} (10 ns)	
Automotive	-40°C to +125°C	2.4V-3.6V	

^{1.} When operated in the range of 2.4V-3.6V, the device meets 10ns. When operated in the range of $3.3V \pm 5\%$, the device meets 8ns.



DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

$V_{DD} = 3.3V \pm 5\%$

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
Vон	Output HIGH Voltage	$V_{DD} = Min., IOH = -4.0 mA$	2.4	_	V
Vol	Output LOW Voltage	$V_{DD} = Min., IoL = 8.0 mA$	_	0.4	V
VIH	Input HIGH Voltage		2	$V_{DD} + 0.3$	V
VIL	Input LOW Voltage(1)		-0.3	0.8	V
Iμ	Input Leakage	$GND \leq V_{IN} \leq V_{DD}$	-1	1	μΑ
ILO	Output Leakage	GND \leq Vout \leq Vdd, Outputs Disabled	-1	1	μΑ

Note:

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

$V_{DD} = 2.4V - 3.6V$

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
Vон	Output HIGH Voltage	$V_{DD} = Min., IOH = -1.0 mA$	1.8	_	V
Vol	Output LOW Voltage	$V_{DD} = Min., I_{OL} = 1.0 \text{ mA}$	_	0.4	V
VIH	Input HIGH Voltage		2.0	$V_{DD} + 0.3$	V
VIL	Input LOW Voltage(1)		-0.3	0.8	V
lu	Input Leakage	$GND \leq Vin \leq Vdd$	-1	1	μA
ILO	Output Leakage	GND ≤ Vout ≤ Vdd, Outputs Disabled	-1	1	μA

Note:

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

$V_{DD} = 1.65V-2.2V$

Symbol	Parameter	Test Conditions	V DD	Min.	Max.	Unit
Vон	Output HIGH Voltage	Iон = -0.1 mA	1.65-2.2V	1.4	_	V
VoL	Output LOW Voltage	IoL = 0.1 mA	1.65-2.2V	_	0.2	V
VIH	Input HIGH Voltage		1.65-2.2V	1.4	$V_{DD} + 0.2$	V
VIL ⁽¹⁾	Input LOW Voltage		1.65-2.2V	-0.2	0.4	V
ILI	Input Leakage	$GND \leq \ V_{IN} \leq \ V_{DD}$		-1	1	μA
ILO	Output Leakage	$GND \leq Vout \leq Vod$, (Outputs Disabled	-1	1	μΑ

Note

V_{IL} (min.) = -0.3V DC; V_{IL} (min.) = -2.0V AC (pulse width 2.0 ns). Not 100% tested.
V_{IH} (max.) = V_{DD} + 0.3V DC; V_{IH} (max.) = V_{DD} + 2.0V AC (pulse width 2.0 ns). Not 100% tested.

^{1.} V_{IL} (min.) = −0.3V DC; V_{IL} (min.) = −2.0V AC (pulse width 2.0 ns). Not 100% tested. V_{IH} (max.) = V_{DD} + 0.3V DC; V_{IH} (max.) = V_{DD} + 2.0V AC (pulse width 2.0 ns). Not 100% tested.

^{1.} V_{IL} (min.) = -0.3V DC; V_{IL} (min.) = -2.0V AC (pulse width 2.0 ns). Not 100% tested. V_{IH} (max.) = V_{DD} + 0.3V DC; V_{IH} (max.) = V_{DD} + 2.0V AC (pulse width 2.0 ns). Not 100% tested.



ACTEST CONDITIONS (HIGH SPEED)

Parameter	Unit (2.4V-3.6V)	Unit (3.3V <u>+</u> 5%)	Unit (1.65V-2.2V)
Input Pulse Level	0.4V to VDD-0.3V	0.4V to VDD-0.3V	0.4V to VDD-0.2V
Input Rise and Fall Times	1.5ns	1.5ns	1.5ns
Input and Output Timing and Reference Level (VRef)	V _{DD} /2	VDD/2 + 0.05	V _{DD} /2
Output Load	See Figures 1 and 2	See Figures 1 and 2	See Figures 1 and 2

ACTEST LOADS

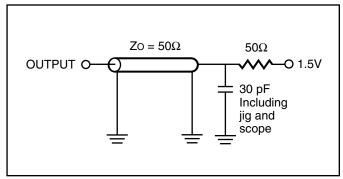


Figure 1.

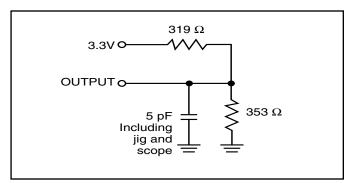


Figure 2.



POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

				-	8	-10		-2	.0	
Symbol	Parameter	Test Conditions		Min.	Max.	Min. I	Max.	Min.	Max.	Unit
Icc	V _{DD} Dynamic Operating	V _{DD} = Max.,	Com.	_	120	_	95	_	90	mA
	Supply Current	$IOUT = 0 \text{ mA}, f = f_{MAX}$	Ind.	_	125	_	100	_	100	
			Auto.	_	_	_	140	_	140	
			typ.(2)			60				
lcc1	Operating	V _{DD} = Max.,	Com.		35	_	30	_	30	mA
	Supply Current	IOUT = 0 mA, f = 0	Ind.	_	35	_	40	_	40	
			Auto.	_	_	_	60		70	
Is _B 1	TTL Standby Current	V _{DD} = Max.,	Com.	_	30	_	30	_	30	mA
	(TTL Inputs)	VIN = VIH or VIL	Ind.	_	35	_	35	_	35	
		$\overline{CE} \ge V_{IH}, f = 0$	Auto.	_	_	_	70	_	70	
IsB2	CMOS Standby	V _{DD} = Max.,	Com.	_	20	_	20	_	15	mA
	Current (CMOS Inputs)	$\overline{CE} \ge V_{DD} - 0.2V$,	Ind.	_	25	_	25	_	20	
		$V_{\text{IN}} \ge V_{\text{DD}} - 0.2V$, or	Auto.	_	_	_	70	_	70	
		$Vin \leq 0.2V, f = 0$	typ.(2)			4				

^{1.} At $f = f_{MAX}$, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

^{2.} Typical values are measured at VDD = 3.0V, $TA = 25^{\circ}C$ and not 100% tested.



READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

		-	8	-10	
Symbol	Parameter	Min.	Max.	Min. Max.	Unit
trc	Read Cycle Time	8	_	10 —	ns
taa	Address Access Time	_	8	- 10	ns
t oha	Output Hold Time	2	_	2 —	ns
tace	CE Access Time	_	8	- 10	ns
tdoe	OE Access Time	_	5.5	— 6.5	ns
thzoe(2)	OE to High-Z Output	_	3	- 4	ns
tLZOE ⁽²⁾	OE to Low-Z Output	0	_	0 —	ns
thzce(2	CE to High-Z Output	0	3	0 4	ns
tLZCE ⁽²⁾	CE to Low-Z Output	3	_	3 —	ns
t PU	Power Up Time	0	_	0 —	ns
t PD	Power Down Time	_	8	— 10	ns

^{1.} Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0V to 3.0V and output loading specified in Figure 1.

^{2.} Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage.



READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

	-20 ns				
Symbol	Parameter	Min.	Max.	Unit	
trc	Read Cycle Time	20	_	ns	
taa	Address Access Time	_	20	ns	
tона	Output Hold Time	2.5	_	ns	
tace	CE Access Time	_	20	ns	
t DOE	OE Access Time	_	8	ns	
thzoe(2)	OE to High-Z Output	0	8	ns	
tLZOE ⁽²⁾	OE to Low-Z Output	0	_	ns	
thzce(2	CE to High-Z Output	0	8	ns	
tLZCE ⁽²⁾	CE to Low-Z Output	3	_	ns	
t PU	Power Up Time	0	_	ns	
t PD	Power Down Time	_	20	ns	

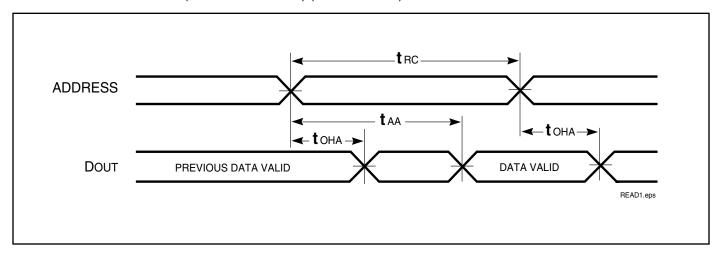
^{1.} Test conditions assume signal transition times of 1.5 ns or less, timing reference levels of 1.25V, input pulse levels of 0.4V to VDD-0.3V and output loading specified in Figure 1.

^{2.} Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

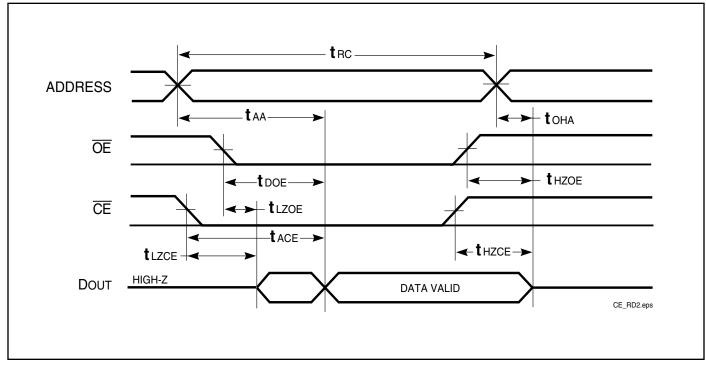
^{3.} Not 100% tested.



AC WAVEFORMS READ CYCLE NO. $1^{(1,2)}$ (Address Controlled) ($\overline{CE} = \overline{OE} = V_{IL}$)



READ CYCLE NO. 2 $^{(1,3)}$ ($\overline{\text{CE}}$ and $\overline{\text{OE}}$ Controlled)



- 1. WE is HIGH for a Read Cycle.
- 2. The device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.
- 3. Address is valid prior to or coincident with $\overline{\text{CE}}$ LOW transitions.



WRITE CYCLE SWITCHING CHARACTERISTICS(1,3) (Over Operating Range)

		-8	3	-10	
Symbol	Parameter	Min.	Max.	Min. Max.	Unit
twc	Write Cycle Time	8	_	10 —	ns
tsce	CE to Write End	6.5	_	8 —	ns
taw	Address Setup Time to Write End	6.5	_	8 —	ns
tha	Address Hold from Write End	0	_	0 —	ns
t sa	Address Setup Time	0	_	0 —	ns
tpwe1	$\overline{\text{WE}}$ Pulse Width ($\overline{\text{OE}} = \text{HIGH}$)	6.5	_	8 —	ns
tPWE2	$\overline{\text{WE}}$ Pulse Width $(\overline{\text{OE}} = \text{LOW})$	8.0	_	10 —	ns
tsp	Data Setup to Write End	5	_	6 —	ns
thd	Data Hold from Write End	0	_	0 —	ns
thzwe ⁽²⁾	WE LOW to High-Z Output	_	3.5	– 5	ns
tLzwe ⁽²⁾	WE HIGH to Low-Z Output	2	_	2 —	ns

Notes:

2. Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

^{1.} Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0V to 3.0V and output loading specified in Figure 1.

^{3.} The internal write time is defined by the overlap of $\overline{\text{CE}}$ LOW and $\overline{\text{WE}}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write. Shaded area product in development



WRITE CYCLE SWITCHING CHARACTERISTICS(1,2) (Over Operating Range)

		-20 ns		
Symbol	Parameter	Min.	Max.	Unit
twc	Write Cycle Time	20	_	ns
tsce	CE to Write End	12	_	ns
taw	Address Setup Time to Write End	12	_	ns
tha	Address Hold from Write End	0	_	ns
t sa	Address Setup Time	0	_	ns
tpwE1	$\overline{\text{WE}}$ Pulse Width ($\overline{\text{OE}}$ = HIGH)	12	_	ns
tpwE2	$\overline{\text{WE}}$ Pulse Width ($\overline{\text{OE}}$ = LOW)	17	_	ns
tsp	Data Setup to Write End	9	_	ns
thd	Data Hold from Write End	0	_	ns
thzwe ⁽³⁾	WE LOW to High-Z Output	_	9	ns
tLZWE ⁽³⁾	WE HIGH to Low-Z Output	3	_	ns

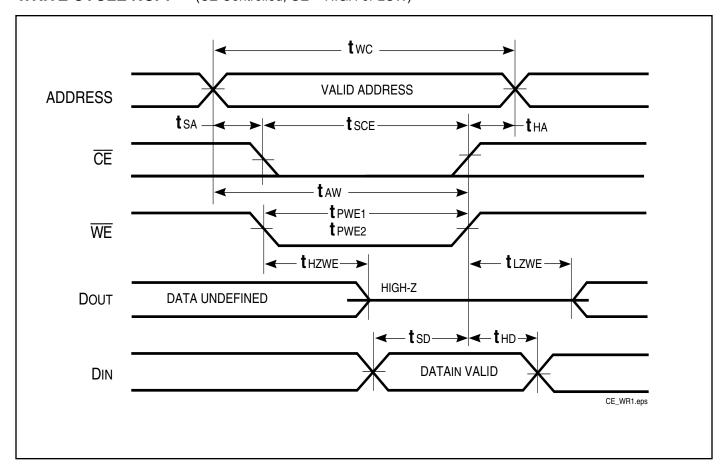
^{1.} Test conditions assume signal transition times of 1.5ns or less, timing reference levels of 1.25V, input pulse levels of 0.4V to Vpp-0.3V and output loading specified in Figure 1.

Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

^{3.} The internal write time is defined by the overlap of $\overline{\text{CE}}$ LOW and $\overline{\text{WE}}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.



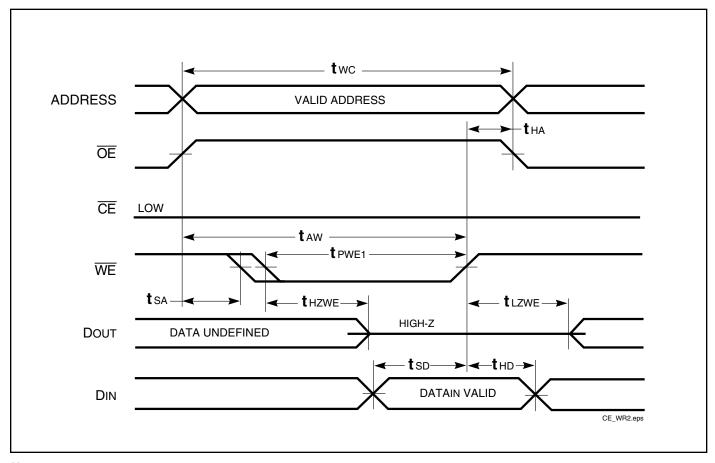
AC WAVEFORMS WRITE CYCLE NO. $1^{(1,2)}$ ($\overline{\text{CE}}$ Controlled, $\overline{\text{OE}}$ = HIGH or LOW)





AC WAVEFORMS

WRITE CYCLE NO. 2^(1,2) (WE Controlled: OE is HIGH During Write Cycle)

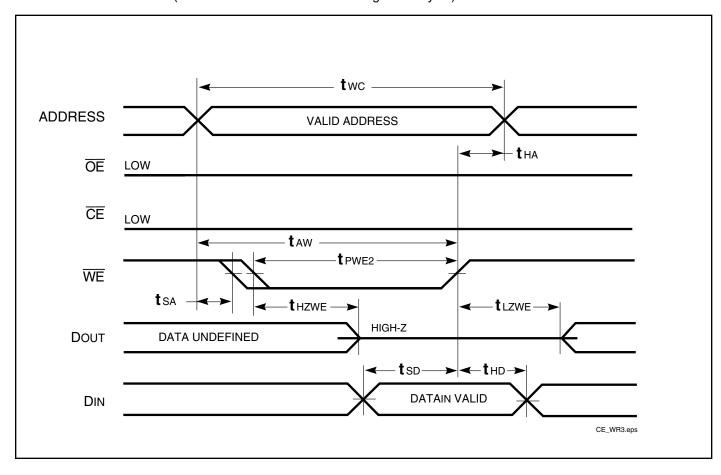


- 1. The internal write time is defined by the overlap of $\overline{\text{CE}}$ LOW and $\overline{\text{WE}}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
- 2. I/O will assume the High-Z state if $\overline{OE} > V_{IH}$.



AC WAVEFORMS

WRITE CYCLE NO. 3 (WE Controlled: OE is LOW During Write Cycle)



IS61WV20488ALL, IS61/64WV20488BLL

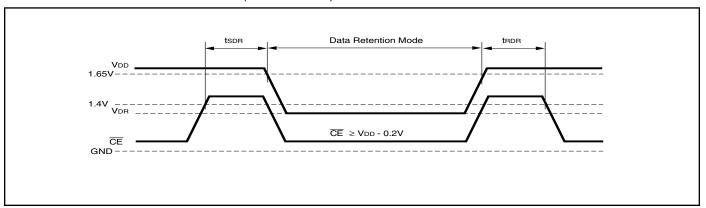


DATA RETENTION SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition		Min.	Max.	Unit
VDR	VDD for Data Retention	See Data Retention Waveform		1.2	3.6	V
IDR	Data Retention Current	$V_{DD} = 1.2V, \overline{CE} \ge V_{DD} - 0.2V$	Ind. Auto. typ. ⁽¹⁾		25 60	mA
tsdr	Data Retention Setup Time	See Data Retention Waveform	ιγρ.	0		ns
trdr	Recovery Time	See Data Retention Waveform		trc	_	ns

Note:

DATA RETENTION WAVEFORM (CE Controlled)



^{1.} Typical values are measured at $V_{DD} = 3.0V$, $T_A = 25$ °C and not 100% tested.



ORDERING INFORMATION

Industrial Range: -40°C to +85°C Voltage Range: 2.4V to 3.6V

Order Part No.	Package
IS61WV20488BLL-10MI	48 mini BGA (9mm x 11mm)
IS61WV20488BLL-10MLI	48 mini BGA (9mm x 11mm), Lead-free
IS61WV20488BLL-10TI	TSOP (Type II)
IS61WV20488BLL-10TLI	TSOP (Type II), Lead-free
	IS61WV20488BLL-10MI IS61WV20488BLL-10MLI IS61WV20488BLL-10TI

Note:

Industrial Range: -40°C to +85°C Voltage Range: 1.65V to 2.2V

Speed (ns)	Order Part No.	Package
20	IS61WV20488ALL-20MI	48 mini BGA (9mm x 11mm)
	IS61WV20488ALL-20TI	TSOP (Type II)

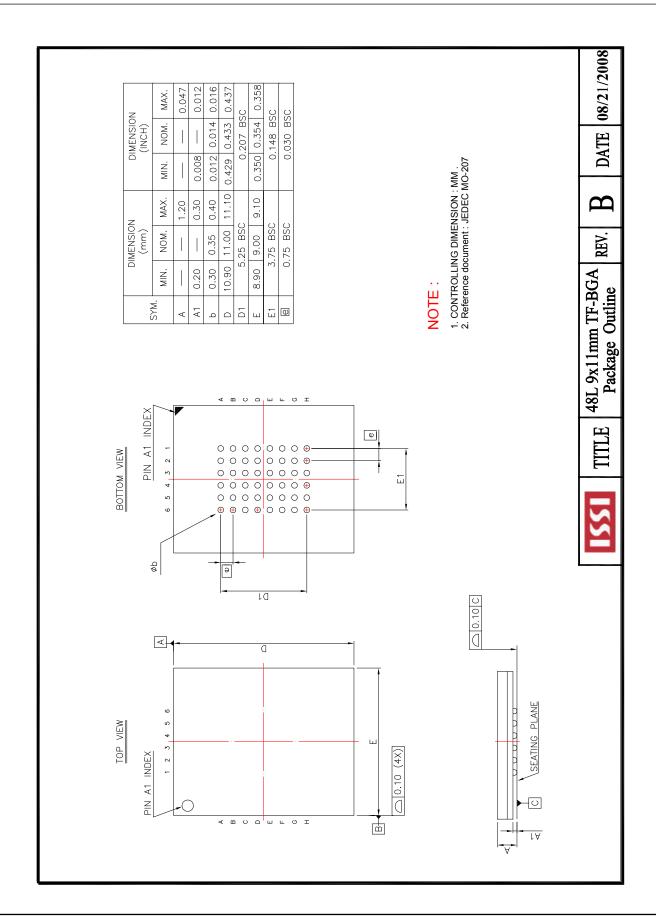
Automotive Range: -40°C to +125°C

Voltage Range: 2.4V to 3.6V

Speed (ns)	Order Part No.	Package
10	IS64WV20488BLL-10MA3	48 mini BGA (9mm x 11mm)
	IS64WV20488BLL-10MLA3	48 mini BGA (9mm x 11mm), Lead-free
	IS64WV20488BLL-10TA3	TSOP (Type II)

^{1.} Speed = 8ns for V_{DD} = 3.3V \pm 5%. Speed = 10ns for V_{DD} = 2.4V to 3.3V.





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